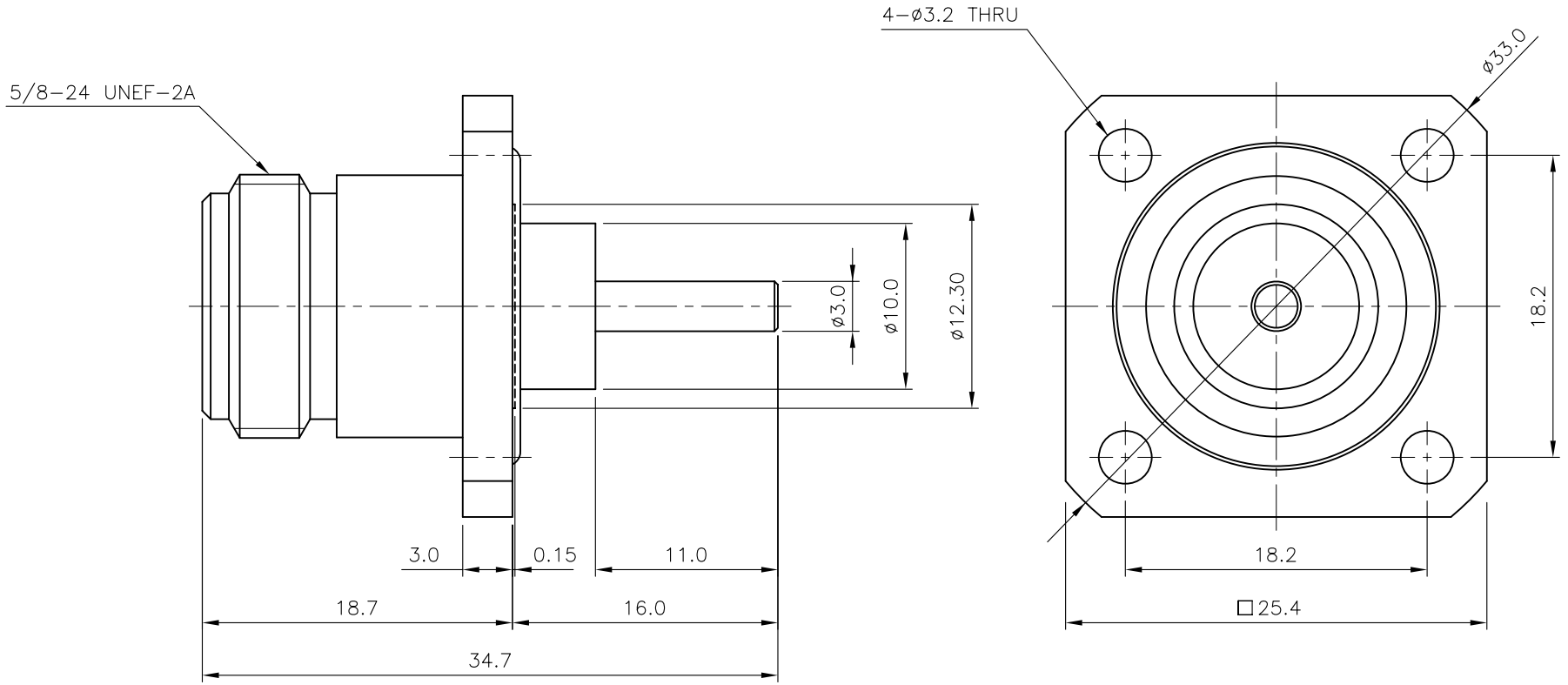
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	I.C.KIM	2012.10.23.



NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
4	GASKET	1	SILICONE RUB		DGK00045-N/1
3	INSULATOR	1	TEFLON		DIN02083-N/1
2	CONTACT	1	BeCu	Silver Plate 3μm	DCT02867-5/1
1	BODY	1	MBsBD	SUCO Plate (3μm)	DBD03175-5/2

TOLERANCE	Decimal ±0.1	DATE	2013. 07. 08.
	Angle ±1°	APPROVED BY	I.C.KIM
MATERIAL		CHECKED BY	
		DRAWN BY	E.H.KIM
FINISH		SCALE 2.5/1	UNIT mm

KJ COMTECH
KJ COMTECH CO.,LTD.
RF & MICROWAVE TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE: N50 SOLDER END JS-4H

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